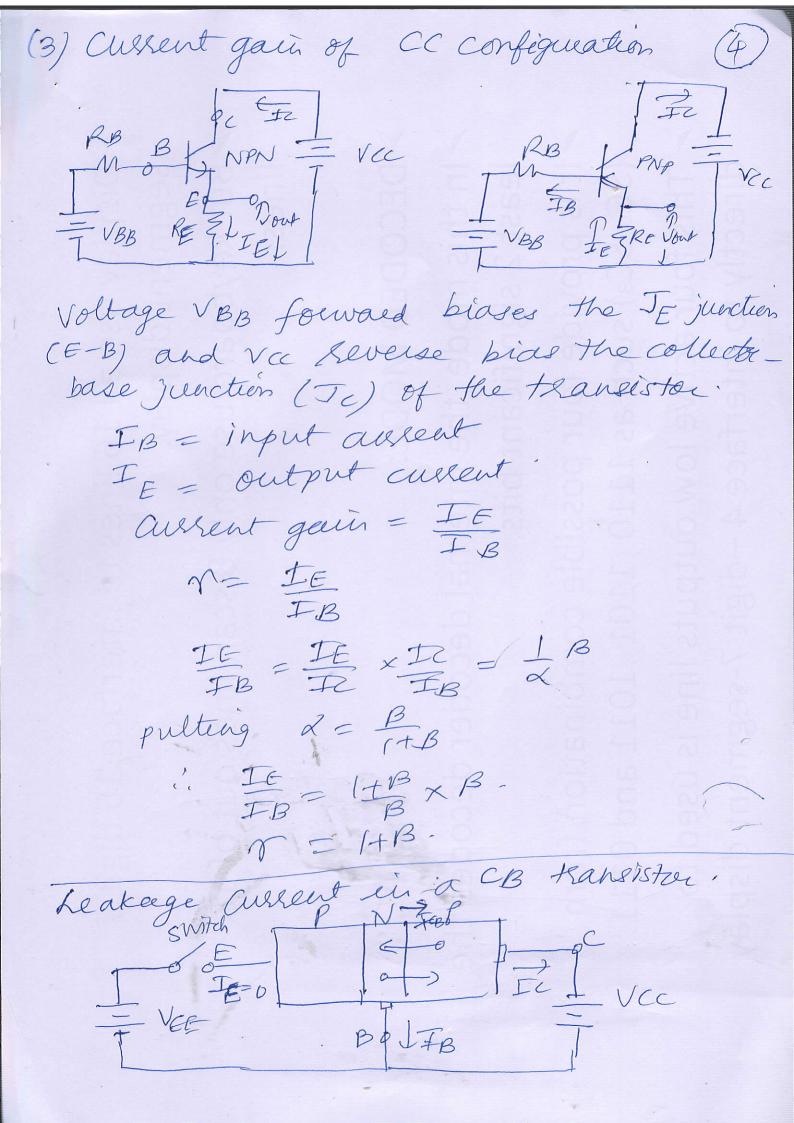


(11) Common base a.c. current gain do: (2)
gt. is defined as the Ratio of small change
in tollector current (A Fe) to a small change en emelter current (a +c) for a constant collector to base voltage (VCB).
It is designated as 20, Lac or 46 do = AIC AIE : cuerent or small signal current gain. For practical purposes . X = LO. Note: Current gain a is less than unity but et es still called culsent gain, It is because the output resistance of B Kansistor is much higher than enput resistance. This produces large voltage gaen and hence large power gach. (2) Common Emitter configuration Current gaen RB IB VCC TVBB FE TVCC IB = Input Oursent Ic = Output current current gain = 1c. (a) Common emiller dic current gain (B) It is defined as the ratio of Icto IB. It is designated as B, Bdc on hFE. 1. B= IC

IC77B· 1. B771 B ranges from 20 to 250. gt is also called as large signal CE current gaus: (b) common emitter a.c. cuesent gain (Po) gt is defined as the satio of small change in collector current (DIc) to the small change in IB (SIB) for a constent collector to Enritter voltage (VCE) gt is designated as Bu, Bac or hope For all practical purposes $B = B_0$. Relation between current gain & and B (divide by te on both sides) IE = IB +IC IE = B+ FC 之=声+1 · · · L = IFB $\left(X = \frac{B}{B+1} \right)$ $\alpha(B+1) = B$ < = B (1-X) 1. B = S 1-2



ci) switch in "closed" position Forward beas voltage injects holes in the Bregin. The leverse bias voltage on the the Ic attracts the majority of holes from B region and constitute Ic. A small number of holes combine with the election in the B segun and constitute IB ' ITE = IC+IB. (ii) suitch in GPEN position: It disconnects & from B and hence E-B junction is open-circuites. Thus It=0 and therefore IB = Ic=0. The CB junction es severse biased due to holes injected from E. But this junction is followed bidsed due to theemally generaled minority carriers (i.e. electrons in the Ptype collector region and holes in the N type B regions. The minority carries diffuse across the C-Bjunction and hence produce a certain value of airlent known as leakinge airelent. This cultent is called the leakage auxent from CtoB with E open and is designated as ICBP. It is also known as reverse saturation auxent or collector out off current Fco. JOBO OF TO IS Démilde to Reverse Saturation delleut en p-hjunction Direction of FCBO is same as that of enjected allent

Ice consests of 2 pacts of mornal transisto (6)
(i) ausent produced by mornal transisto (6)
action and is equal to XIE and is the to majority carriers (ii) The severse saturation dissent ICo produced by the thermally generated callies de minority decies in IC= & IE+ICO X = IC - ICOIC+IB LIC+LIB = IC-ICO IC- LICE LIB-ICO IC (FL) = & IB-ICO ICC XIB - ICO I-X Note: Ico for Si transistoes es en nA whereas for Sin Ge transistors it is light : annot be neglected. is strongly temperature dependent. It doubles fele every 10°c encrease en temperatue As Iw is less in Si translitous they any be used upto 200° whereas Ge kansisos are limited to about 1000 only

Leakage current en a CE transistor Switch FEED RC

RB IB=0 IP TE

VBB TTE ci/ Switch in closed position: (The descripteur is some est foi bokage cuerent in CB transistor (11) switch in open position; Base is discennected from the amillier-Hence the B-E Junction is opened and IB=0. Under this condition, a leakage discert flows from E to C terminal. This allert is designated by ICEO. This leakage current is not just due to the theemally generate, carrier avois C-B junction but also due to movement of elections across the B-E Junction. This flow of electrons slightly forward biase the B-E junction. It appears as if a base current Equal to Ico is being supplied to the teansister. This Produces additional collector equal to

Thus the total leakage cultent flowing (8) through the kausiston with Base open ICEO = IW + BICO $= (1+B) \pm Co.$ The total Ic = B IB+ ICFO IC = B FB + (1+B) ICO Note: As Ico is temperature dependent , as temperature changes there is a Change en IC. As B>>1 therefore CE transistor is more temperature dependent those CB transistor. Base spreading resistance: Width of B region is entremely 2 mall: Therefore the current which enters the B region across the E-Bjunction hers a nassow path to seach the Base terminal. The resistance offered by this narrow base region is called bose spreading resistance 86' The value of this resistance can be increased by increasing the reversebias voltage VCB orcross C-B junction. 26 is about 50 to 150 ohms. 94 some cases it may be as high as 1000 ohms. Effect of 86 es significant at high frequencies